

PDS5100H

5A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER

PowerDI[®]5

Features

- Guard Ring Die Construction for Transient Protection
- High Maximum Junction Temperature
- Very Low Leakage Current
- Highly Stable Oxide Passivated Junction
- Low Forward Voltage Drop
- High Forward Surge Current Capability
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability



Top View

Mechanical Data

- Case: PowerDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.096 grams (approximate)

BOTTOMSIDE HEAT SINK LEFT PIN O RIGHT PIN O

Note: Pins Left & Right must be electrically connected at the printed circuit board.

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.			
Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	100	V
RMS Reverse Voltage	V _{R(RMS)}	71	V
Average Rectified Output Current (See also figure 5)	lo	5	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	250	А

Thermal Characteristics

Characteristic	Symbol	Tu m	Max	Unit
Characteristic	Syllibol	Тур	Iviax	Unit
Thermal Resistance Junction to Soldering Point	$R_{ ext{ heta}JS}$	—	2.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 2) $T_A = 25^{\circ}C$	$R_{ heta JA}$	85	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 3) $T_A = 25^{\circ}C$	$R_{ hetaJA}$	70	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 4) $T_A = 25^{\circ}C$	$R_{ ext{ heta}JA}$	45	—	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to	+175	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V _{(BR)R}	100		_	V	I _R = 3.5μA
		_	0.67	0.71	V	$I_F = 5A, T_S = 25^{\circ}C$
Forward Voltage	¥-		0.55	0.58		I _F = 5A, T _S = 125°C
	VF		0.75	0.80		I _F = 10A, T _S = 25°C
			0.62	0.66		I _F = 10A, T _S = 125°C
Reverse Leakage Current (Note 5)	le.	_	0.3	3.5	μΑ	$T_{S} = 25^{\circ}C, V_{R} = 100V$
	IR		0.5	4.5	mA	$T_S = 125^{\circ}C, V_R = 100V$

1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes. Notes:

2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.

3. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.

4. Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.

5. Short duration pulse test used to minimize self-heating effect.

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= +125°C

= +85°C

T_i = +25°C

0.8 0.9 1.0

= -65°C

Fig. 2 Typical Forward Characteristics

T_J = 125°C

T_J = 85°C

Fig. 4 Typical Reverse Characteristics

Note 4

100

T_A, AMBIENT TEMPERATURE (°C)

Fig. 6 Forward Current Derating Curve

125

150

Note 2

75

25

50

60

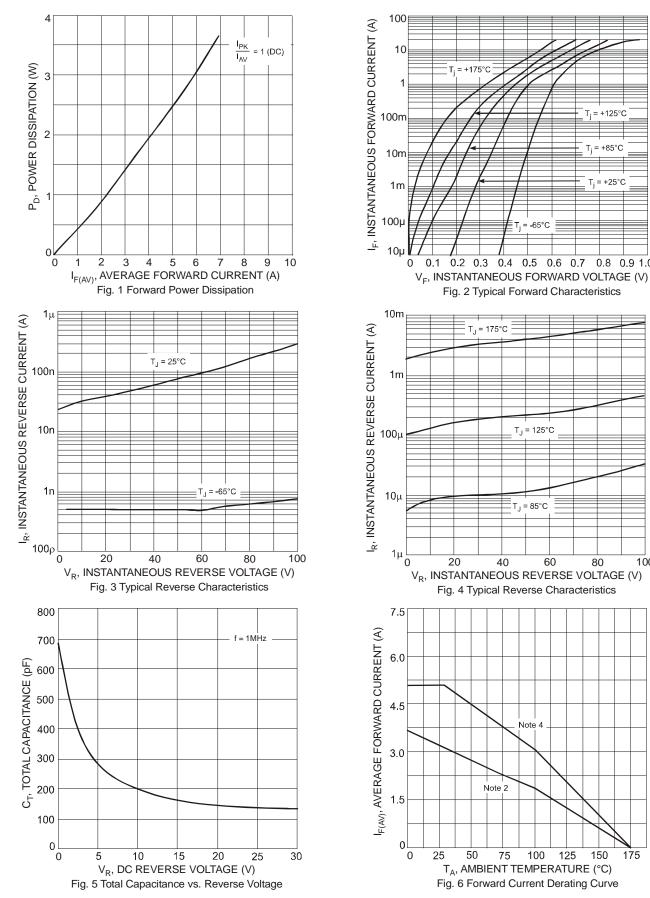
40

0.2 0.3 0.4 0.5 0.6 0.7

= +175°C

T_1 = 175°C

20



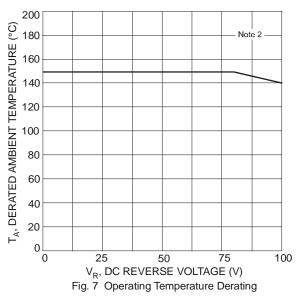
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175

100

80



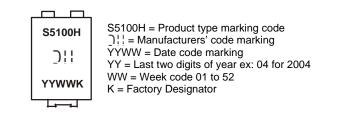


Ordering Information (Note 6)

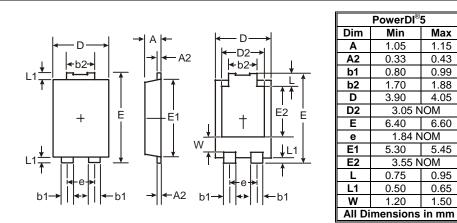
Part Number	Case	Packaging
PDS5100H-13	PowerDI [®] 5	5000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



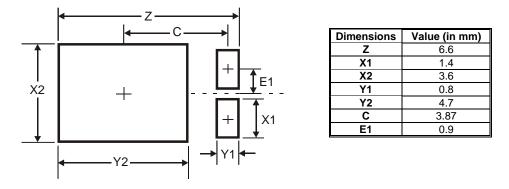
Package Outline Dimensions



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Suggested Pad Layout



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